# Avionics Series MFCC-8556



Freescale® QorlQ® P2 Conduction-cooled Single Board Computer PMC/XMC Module

- Designed for DAL-C (DO-178C/DO-254) certification
- Freescale® QorlQ® P2020 processor
- Xilinx Spartan®-6 LXT user-programmable FPGA (1)
- Mercury Advanced Board Management Controller
- 1x PCle x2 on XMC <sup>(1)</sup>, 2x GbE on PMC/XMC <sup>(1)</sup>
- 1x USB 2.0 on PMC/XMC (1), 3x UARTs on PMC/XMC (1)



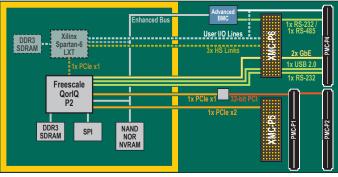
(1) Optional

Mercury is bringing the highest level of flight-safety assurance for aerospace and defense applications. Our proven, reusable Design Assurance Level (DAL) certified artifacts for mission computing, avionics, networking and datalink comms processing save time/cost and decrease risk.

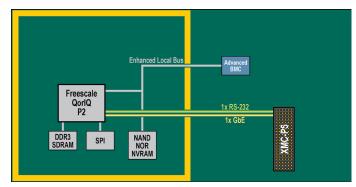
Mercury's Avionics Series MFCC-8556 is a powerful processing solution packaged in a PMC/XMC form-factor for airborne conduction-cooled applications. The MFCC-8556 is designed for the most demanding missions, combining high compute power and flightworthiness capabilities in harsh environments.

The MFCC-8556 is Mercury's sixth generation PMC/XMC PowerPC multi-function processing solution, featuring a fast dual-core processor with high-speed links and bridges (PCIe, GbE) and an optional user-programmable FPGA for application development.

An Advanced Board Management Controller is implemented for configuration management, event logging and other supporting tasks. It monitors and controls the system continuously, ensuring reliability and safety even in the case of failure conditions.



MFCC-8556GF



MFCC-8556PF

Mercury Systems is a leading commercial provider of secure sensor and mission processing subsystems. Optimized for customer and mission success, Mercury's solutions power a wide variety of critical defense and intelligence programs.













# **Technical Specifications**

# **Compliance**

PMC: VITA 20, VITA 32

XMC: VITA 42

# **Power Consumption**

minimum typical maximum units 12(1) Watts

#### **Processor**

Freescale QorlQ P2020 (2 cores) @ 1.0 GHz

# Memory

512 MB/2 GB DDR3 SDRAM @ 6.4 GB/s peak with ECC protection

2 GB Flash (NAND)

128 MB Flash (NOR)

256 KB NVRAM

# **User Programmable FPGA I/0**

Xilinx Spartan-6 LXT FPGA with 128 MB DDR3 SDRAM (B) (D) (G) User-specific I/O lines on PMC-P4/XMC-P6 (B) (D) (G) (L)

#### **Buses**

1x 32-bit PCI 3.0 bus at 33/66 MHz on PMC-P1/P2 (B) (G) (L)

## **Links / Connections**

1x PCIe x2 on XMC-P5 (VITA 42.3) (D) (G)

3x high-speed links on user-programmable FPGA to XMC-P6 (D) (G)

2x 1000Base-T on PMC-P4/XMC-P6 (B) (D) (G)

1x 10/100Base-T on PMC-P4(L)

1x 10/100/1000Base-T on XMC-P5 (P)

1x USB 2.0 host / device on PMC-P4/XMC-P6 (B) (D) (G)

2x RS-232 on PMC-P4/XMC-P6 (B) (D) (G)

1x RS-232 on PMC-P4 (L)

1x RS-232 on XMC-P5 (P)

1x selectable RS-422/485 on PMC-P4/XMC-P6 (B) (D) (G) (L)

(1) Without FPGA user functionality

(B), (C), (D), (G), (L) and (P) applies to B, C, D, G, L and P model options

#### **Advanced Board Management Controller**

CPU speed control logic

Advanced power management

Voltage and current monitoring

Temperature monitoring (thermal sensors on critical positions)

Advanced error reporting and logging

# **Development / Debug**

Onboard JTAG test port

## **Ruggedization Levels**

Leve	Description	Cooling Type	Operating Temperature	Vibration (1 hour per axis)	Operating Shocks
C4	Extended range CC	Conduction	-40°C to 85°C [CC4]	5-100 Hz: increase at 3 dB/octave, 100-1000 Hz: 0.1 g <sup>2</sup> /Hz, 1000-2000Hz: decrease at 6 dB/octave	40g, 11ms saw-tooth, three axes

# **Environmental Specifications**

Condition	Limits, standards	Comments
Non-operating temperature	-55°C to 105°C [C4]	
Humidity	95%	
Altitude	-1,500 to 60,000 feet	May require conformal coating
Fungus resistance	No nutrient materials	
Workmanship	IPC-A-160 class 3	
Soldering	IPC J-STD-001 class 3	
PCB Manufacturing	IPC-A-600 class 3	
Conformal coating	IPC-CC-830	Optional
Materials	REACH compliant	ROHS variants as an option
Flammability	UL 94 Class V-0	
Quality	EN 9100:2008	

# **Product Ordering**

MFCC-556BF Conduction-cooled PMC with QorlQ P2020 @ 1.0 GHz,

512 MB DDR3, 2 GB NAND, 128 MB NOR, 256 KB NVRAM,

Spartan-6 LXT 128 MB DDR3

MFCC-8556DF Conduction-Cooled XMC with QorlQ P2020 @ 1.0 GHz,

512 MB DDR3, 2 GB NAND, 128 MB NOR, 256 KB NVRAM

Spartan-6 LXT with 128 MB DDR3

MFCC-8556LF Conduction-cooled PMC with QorlQ P2020 @ 1.0 GHz,

512 MB DDR3, 2 GB NAND, 128 MB NOR, 256 KB NVRAM

(pin-out: MFCC-8448 compatible)

MFCC-8556PF Conduction-cooled XMC with QorlQ P2020 @ 1.0 GHz,

512 MB DDR3, 2 GB NAND, 128 MB NOR, 256 KB NVRAM

(no XMC-P6)

MFCC-8556DH Conduction-cooled XMC with QorlQ P2020@1.0GHz

2GB DDR3, 2GB NAND, 128MB NOR, 256KB NVRAM,

Spartan-6 LXT with 128MB DDR3

Conformal coating versions of these boards are also available.

OWW-36410A VxWorks® BSP for MFCC-8550/56 OWW-36410E VxWorks 653 BSP for MFCC-8550/56 OWX-36410L Linux® Toolbox for MFCC-8550/56

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